# TC52x/TC57x Series Specifications

Backlight         LED backlight           Power         Rechargeable Li-Ion, PowerPrecision+, ≥ 15.48 Watt hours, ≥ 4150 mAh, improved battery metrics for better battery management, fast charging (up to 2.4 A); Warm Swap battery mode up to two minutes (120 seconds)           Expansion Slot         User accessible MicroSD supports up to 256 GB SDXC           SIM Slots         TC57x only: 1 nano SIM; 1 eSIM           Network         TC52x/TC57x: WLAN, WPAN (Bluetooth), USB 2.0, High Speed (Host and Client) TC57x only: WWAN           Notification         Audible tone; multi-color LEDs; vibration           Keypad         On-screen keypad and enterprise keyboard           Voice and Audio         Three microphones with noise cancellation; vibrate alert; front facing speaker; Bluetooth wireless headset support; high quality speaker phone; PTT headset support; cellular circuit switch voice; HD voice; Super-wideband (SWB) and Fullband (FB) audio; 3.5mm audio jack           Buttons         Four programmable buttons for maximum flexibility: dual dedicated scan buttons, dedicated push-to-talk button and volume up/down buttons           Performance Characteristics	Physical Characteristics	
Display   5.0 in. Full High Definition (1920 x 1080); exceptionally bright, outdoor viewable; optically bonded to touch panel	Dimensions	
exceptionally bright, outdoor viewable; optically bonded to touch panel  Imager Window  Corning Gorilla Glass  Touchpanel  Dual mode capacitive touch with stylus or bare or gloved fingertip input (conductive stylus sold separately); Corning Gorilla Glass; water droplet rejection; fingerprint resistant anti-smudge coating  Backlight  LED backlight  Power  Rechargeable Li-lon, PowerPrecision+, ≥ 15.48 Watt hours, ≥ 4150 mAh, improved battery metrics for better battery management, fast charging (up to 2.4 Å); Warm Swap battery mode up to two minutes (120 seconds)  Expansion Slot  User accessible MicroSD supports up to 256 GB SDXC  SIM Slots  TC57x only: 1 nano SIM; 1 eSIM  Network  Connections  TC52x/TC57x: WLAN, WPAN (Bluetooth), USB 2.0, High Speed (Host and Client) TC57x only: WWAN  Notification  Audible tone; multi-color LEDs; vibration  Keypad  On-screen keypad and enterprise keyboard  Voice and Audio  Three microphones with noise cancellation; vibrate alert; front facing speaker; Bluetooth wireless headset support; high quality speaker phone; PTT headset support; cellular circuit switci voice; HD voice; Super-wideband (SWB) and Fullband (FB) audio; 3.5mm audio jack  Buttons  Four programmable buttons for maximum flexibility: dual dedicated scan buttons, dedicated push-to-talk button and volume up/down buttons  Performance Characteristics  CPU  Qualcomm Snapdragon* 660 octa-core, 2.45 GHz  Operating System  Android 10, upgradeable through Android 11  Memory  4GB RAM/32GB UFS Flash  User Environment  Operating Temp.  4°F to 122°F/-20°C to 50°C  Storage Temp.  4°F to 158*F/-40°C to 70°C  Humidity  5% to 95% non-condensing  Drop Specifications  Multiple 6 ft. drops to concrete with the rugged boot accessory per Mil STD 810 G; multiple 4 tt/1.2m drops to tile over concrete -10°C to 50°C (14°F to 122°F)  Tumble Specification  500 1.6 ft.//0.5 m tumbles, meets or exceeds IEC tumble specification	Weight	8.8 oz./249 g with battery
Touchpanel  Dual mode capacitive touch with stylus or bare or gloved fingertip input (conductive stylus sold separately); Corning Gorilla Glass; water droplet rejection; fingerprint resistant anti-smudge coating  Backlight  LED backlight  Rechargeable Li-lon, PowerPrecision+ ≥ 15.48 Watt hours, ≥ 4150 mAh, improved battery metrics for better battery management, fast charging (up to 2.4 A); Warm Swap battery mode up to two minutes (120 seconds)  Expansion Slot  User accessible MicroSD supports up to 256 GB SDXC  SIM Slots  TC57x only: 1 nano SIM; 1 eSIM  Network  Connections  High Speed (Host and Client) TC57x only: WWAN  Notification  Audible tone; multi-color LEDs; vibration  Keypad  On-screen keypad and enterprise keyboard  Voice and Audio  There microphones with noise cancellation; vibrate alert; front facing speaker; Bluetooth wireless headset support; ellular circuit switch voice; HD voice; Super-wideband (SWB) and Fullband (FB) audio; 3.5mm audio jack  Buttons  Four programmable buttons for maximum flexibility: dual dedicated scan buttons, dedicated push-to-talk button and volume up/down buttons  Performance Characteristics  CPU  Qualcomm Snapdragon™ 660 octa-core, 2.45 GHz  Operating System  Android 10, upgradeable through Android 11  Memory  4GB RAM/32GB UFS Flash  User Environment  Operating Temp.  -4°F to 122°F/-20°C to 50°C  Storage Temp.  40°F to 158°F/-40°C to 70°C  Humidity  Touble Specifications  Multiple 6 ft. drops to concrete with the rugged boot accessory per Mil STD 810 G; multiple 4 ft/17.2m drops to tile over concrete -10°C to 50°C (14°F to 122°F)  Tumble Specification  Flow and P65 with battery per applicable IEC	Display	exceptionally bright, outdoor viewable;
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	Tumble Specification	
	Sealing	I

User Environment (C	User Environment (Continued)	
Vibration	4 g's PK Sine (5 Hz to 2 kHz); 0.04 g 2/Hz Random (20 Hz to 2 kHz); 60 minute duration per axis, 3 axis	
Thermal Shock	-40°F to 158° F/-40°C to 70°C rapid transition	
Electrostatic Discharge (ESD)	+/-15 kV air discharge; +/- 8 kV direct discharge; +/- 8 kV indirect discharge	
Interactive Sensor To	echnology (IST)	
Light Sensor	Automatically adjusts display backlight brightness	
Magnetometer	eCompass automatically detects direction and orientation	
Motion Sensor	3-axis Accelerometer with MEMS Gyro	
Pressure Sensor	Automatically detects altitude information for locating (TC57x only)	
Proximity Sensor	Automatically detects when the user places the handset against head during a phone call to disable display output and touch input	
Data Capture		
Scanning	SE4720 1D/2D Imager	
Camera	Front — 5 MP Rear — 13 MP autofocus; flash LED generates balanced white light; supports Torch mode	
NFC	ISO 14443 Type A and B; FeliCa and ISO 15693 cards; P2P mode and Card Emulation via Host. Card Emulation via Host and UICC	
Wireless WAN, Data	and Voice Communications (TC57x Only)	
Radio Frequency Band	Supports VoLTE , Carrier Aggregation up to 3DL CA AT&T FirstNet Ready certification Verizon PNTM certification LTE FDD: 700/800/850/900/1800/1900/AWS/2100/2600 (28,13,14,12,17/19,20/5,26/8/3/2,25/4,66/1/7); LTE TDD: 1900/2300/2500 (39/40/41,38); UMTS/HSPA/HSPA+: 850/900/AWS/1900/2100 (5/8/4/2/1); GSM/GPRS/EDGE: 850/900/1800/1900	
GPS	TC57x only: Autonomous, Concurrent GPS; GLONASS; Gallileo; BeiDou, and A-GPS. Supports IZAT™ XTRA	
Multimedia	Wi-Fi Multimedia™ (WMM) and WMM-PS; Including TSPEC	
Wireless LAN		
Radio	IEEE 802.11 a/b/g/n/ac/d/h/i/r/k/v/w; Wi-Fi™ certified; IPv4, IPv6, 5GHz 2x2 MU-MIMO	
Data Rates	5GHz: 802.11a/n/ac — up to 866.7 Mbps 2.4GHz: 802.11b/g/n — up to 300 Mbps	
Operating Channels	Channel 1-13 (2412-2472 MHz): 1,2,3,4,5,6,7,8,9,10,11,12,13 Channel 36-165 (5180-5825 MHz): 36,40,44,48,52 56,60,64,100,104,108,112,116,120,124,128,132,136,1 40,144,149,153,157,161,165 Channel Bandwidth: 20, 40, 80 MHz Actual operating channels/ frequencies and bandwidths depend on regulatory rules and certification agency.	

Continued on page 4

# TC52x/TC57x **Series vertical** markets and applications:

#### **Retail Associates**

- Price/inventory checks
- · Loyalty apps
- · Item locator
- Price management
- Line busting/POS
- · Assisted selling
- · Electronic coupons
- · Store transfers
- Gift registry lookup

# **Retail Managers**

- Workforce management
- Planogram management
- Promotion compliance
- Merchandising

#### **Direct Store Delivery Drivers**

- Order automation
- · Delivery tracking
- Inventory management
- Customer support

## Field Service Technicians

- · Asset management
- Parts inventory
- Invoicing
- Scheduling and location-based

## Parcel/Light **Courier Drivers**

- · Proof of delivery
- · Asset management
- · Location services
- Invoicing

## Government/ **Public Safety**

- eCitation
- Public transportation ticketing
- Situational awareness
- Communication and collaboration
- Asset management